

FGH20N60UFD 600 V, 20 A Field Stop IGBT

Features

- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} =1.8 V @ I_C = 20 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

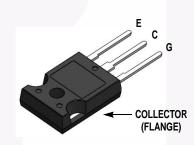
Applications

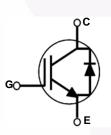
• Solar Inverter, UPS, Welder, PFC

March 2015

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description	Ratings	Unit		
V _{CES}	Collector to Emitter Voltage	600	V		
Gate to Emitter Voltage			±20	V	
V _{GES}	Transient Gate-to-Emitter Voltage	±30			
Collector Current @ $T_C = 2$		@ T _C = 25°C	40	A	
I _C	Collector Current	20	А		
I _{CM (1)}	Pulsed Collector Current@ $T_C = 25^{\circ}C$		60	А	
IF	Diode Forward Current	@ T _C = 25 ^o C	20	А	
'F	Diode Forward Current	10	А		
I _{FM (1)}	Pulsed Diode Maximum Forward Cu	60	А		
P _D	Maximum Power Dissipation $@ T_C = 25^{\circ}C$		165	W	
. D	Maximum Power Dissipation	@ T _C = 100°C	66	W	
TJ	Operating Junction Temperature	-55 to +150	°C		
T _{stg}	Storage Temperature Range	-55 to +150	°C		
Τ _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	300	°C		

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Part Nu	Part Number Top Mark Package		Packing Method	Reel Size	Т	ape Wid	lth Q	Quantity		
FGH20N60	FGH20N60UFDTU FGH20N60UFD TO-247			Tube	N/A		N/A		30	
Electric	al Ch	aracteristics	s of the IC	GBT $T_{C} = 25^{\circ}C$ unless other	wise noted					
Symbol		Parameter	•	Test Conditio	ns M	in.	Тур.	Max.	Unit	
-	Ļ						ļ			
Off Charac	1									
BV _{CES}		or to Emitter Breako	-	$V_{GE} = 0 V, I_{C} = 250 \mu A$		00	-	-	V	
ΔBV_{CES} / ΔT_{J}	Temper Voltage	ature Coefficient of	Breakdown	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$		- 0.		-	V/ºC	
I _{CES}	Collecto	or Cut-Off Current		$V_{CE} = V_{CES}, V_{GE} = 0 V$		-	-	250	μA	
I _{GES}	G-E Le	akage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$				±400	nA	
On Charac	teristics									
V _{GE(th)}	1	reshold Voltage		I _C = 250 μA, V _{CE} = V _{GE}	4	.0	5.0	6.5	V	
0=(11)		5		$I_{\rm C} = 20$ A, $V_{\rm GF} = 15$ V		-	1.8	2.4	V	
V _{CE(sat)}	Collecto	or to Emitter Satura	tion Voltage	$I_{C} = 20 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$		-	2.0	-	v	
Dynamic C	1						0.40	_	~	
C _{ies}	-	apacitance		V _{CE} = 30 V, V _{GE} = 0 V,		-	940	-	pF	
C _{oes}				f = 1 MHz		-	110	-	pF	
C _{res}	Revers	e Transfer Capacita	ance			-	40	-	pF	
Switching	Charact	eristics								
t _{d(on)}	Turn-On Delay Time				-	13	-	ns		
t _r	Rise Ti			-		-	17	-	ns	
t _{d(off)}	Turn-O	ff Delay Time		$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A}, \text{ R}_{G} = 10 \Omega, \text{ V}_{GE} = 15 \text{ V},$		-	87	-	ns	
t _f	Fall Tim	ne				-	32	64	ns	
Eon	Turn-O	n-On Switching Loss		Inductive Load, $T_C = 25^{\circ}C$		-	0.38	-	mJ	
E _{off}	Turn-O	ff Switching Loss		-		-	0.26	-	mJ	
E _{ts}	Total Sv	witching Loss		-		- /	0.64	-	mJ	
t _{d(on)}	Turn-O	n Delay Time				_	13	- /	ns	
t _r	Rise Ti	me				-	16	-	ns	
t _{d(off)}	Turn-O	ff Delay Time		V _{CC} = 400 V, I _C = 20 A,		-	92	-	ns	
t _f	Fall Tim	ne		$R_{G} = 10 \Omega$, $V_{GE} = 15 V$,	-0.0	-	63	-	ns	
E _{on}	Turn-O	n Switching Loss		Inductive Load, T _C = 125	5.6	-	0.41	- /	mJ	
E _{off}	Turn-O	ff Switching Loss				-	0.36	-	mJ	
E _{ts}	Total Sv	witching Loss				-	0.77	- \	mJ	
Qg	Total G	ate Charge				-	63	-	nC	
Q _{ge}	Gate to	Emitter Charge		$V_{CE} = 400 \text{ V}, I_{C} = 20 \text{ A},$		-	7	-	nC	
Q _{gc}	Gate to	Collector Charge		V _{GE} = 15 V		-	32		- nC	

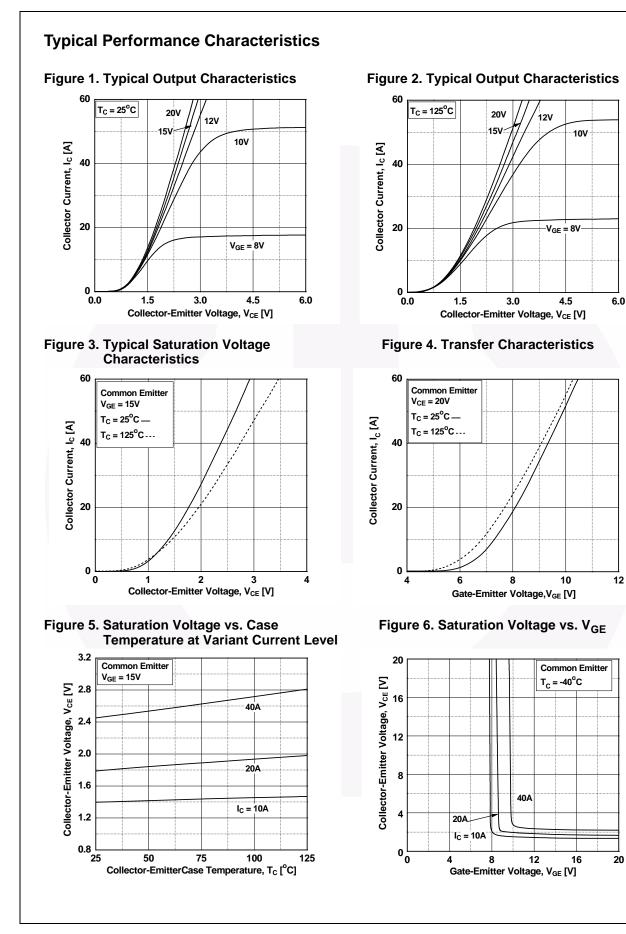
Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.76	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	2.51	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W	

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Test Condition	ns	Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _E = 10 A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.9	2.5	V	
· FIM				$T_{C} = 125^{\circ}C$	-	1.7	-	
t	Diode Reverse Recovery Time	- Ι _F =10 A, di _F /dt = 200 A/μs	$T_C = 25^{\circ}C$	-	34	-	ns	
۲r			$T_{C} = 125^{\circ}C$	-	57	-		
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	41	-	nC	
11				$T_{C} = 125^{\circ}C$	-	96	-	

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Typical Performance Characteristics

Figure 7. Saturation Voltage vs. V_{GE}

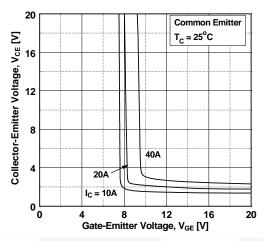


Figure 9. Capacitance Characteristics

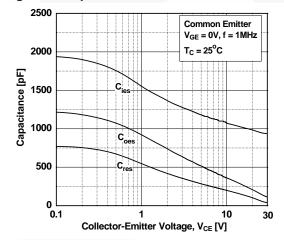


Figure 11. SOA Characteristics

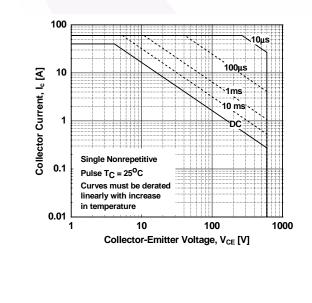


Figure 8. Saturation Voltage vs. V_{GE}

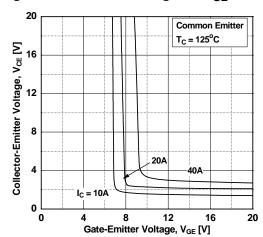


Figure 10. Gate charge Characteristics

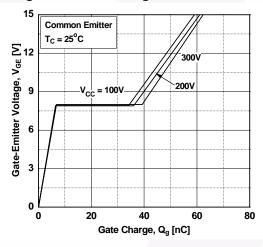
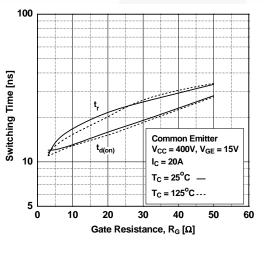
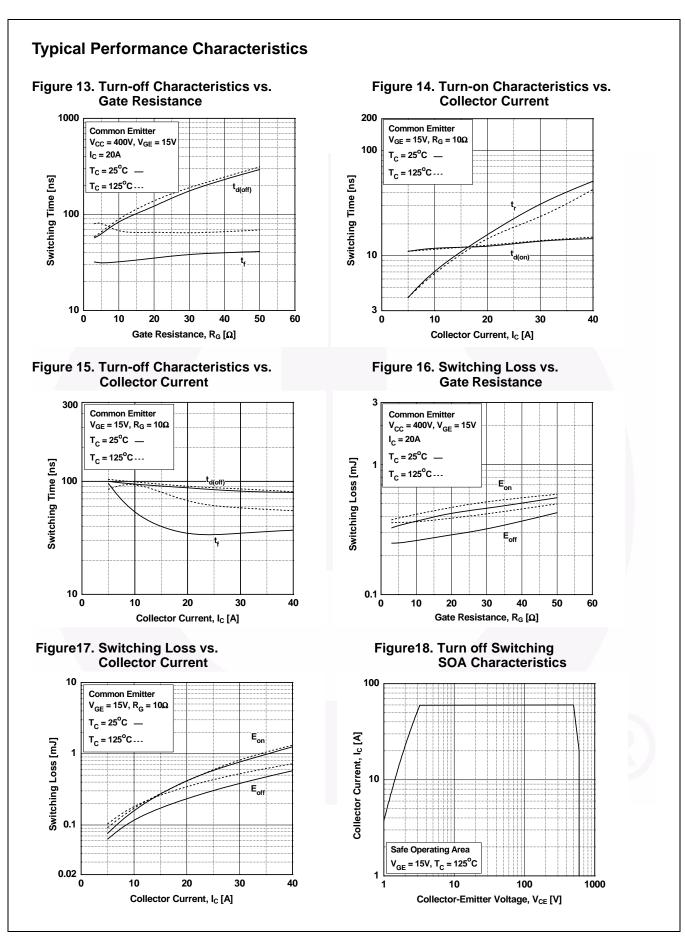
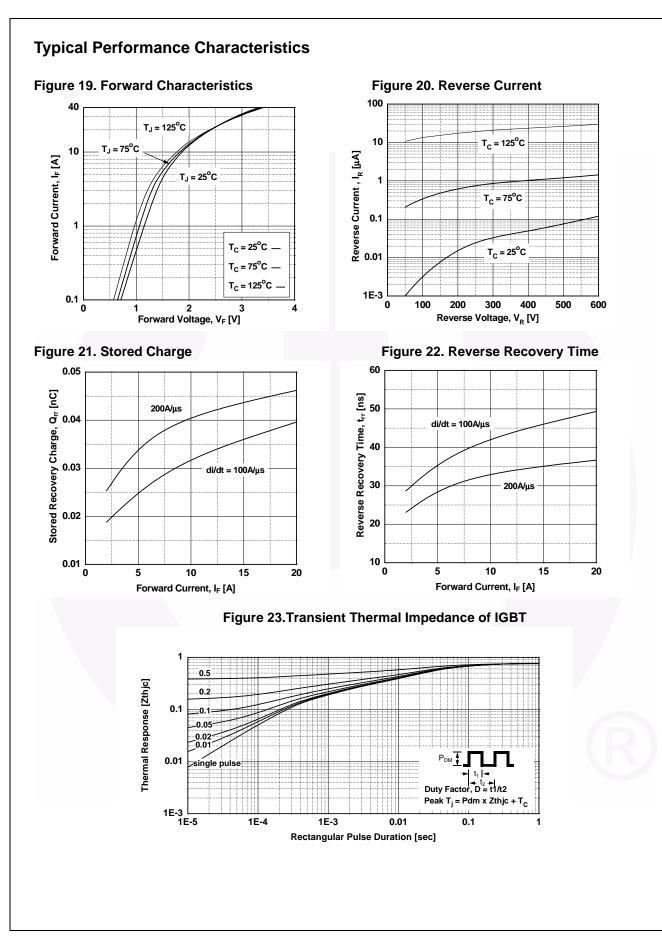


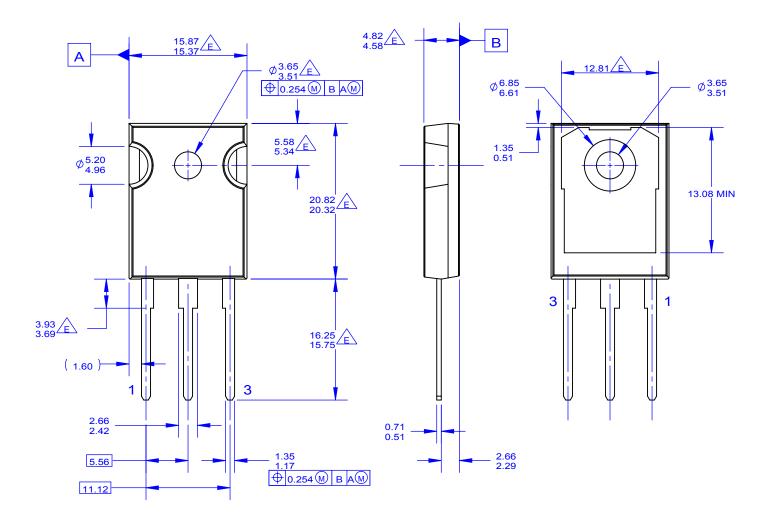
Figure 12. Turn-on Characteristics vs. Gate Resistance





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